



TAIMIDE

ALWAYS BE THE BEST IN THE INDUSTRY

Taiwan Polyimide

We know Polyimide

免責聲明

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公司及產品簡介

2014年3Q營運績效

Q & A

公司及產品簡介



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Company Profile



*Polyimide Film
Manufacturer*

- **Established: June, 2000**
- **Company capital: 38M USD**
- **Plant sites: Hsinpu & Tongluo**
- **Employees: 310 (10% R&D & Process..)**
- **IPO in TSE: October, 2011**



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Milestones

◆ 達邁沿革

- 2000.06 達邁科技股份有限公司成立
- 2001.12 T1產線開始試車
- 2004.08 通過 ISO9001認證
- 2004.12 第二廠區開始興建
- 2005.10 與日本荒川化學合作共同開發Si-H PI
- 2006.09 T3產線開始量產
- 2007.05 T2試驗線開始使用
- 2007.12 與日商JFEC合作研發IC 封裝應用之聚醯亞胺膜
- 2010.07 核准入科學園區
- 2010.12 通過 ISO14001 & OHSAS18001 認證
- 2011.10 股票上市
- 2012.Q2 T4產線計劃開始量產

◆ History

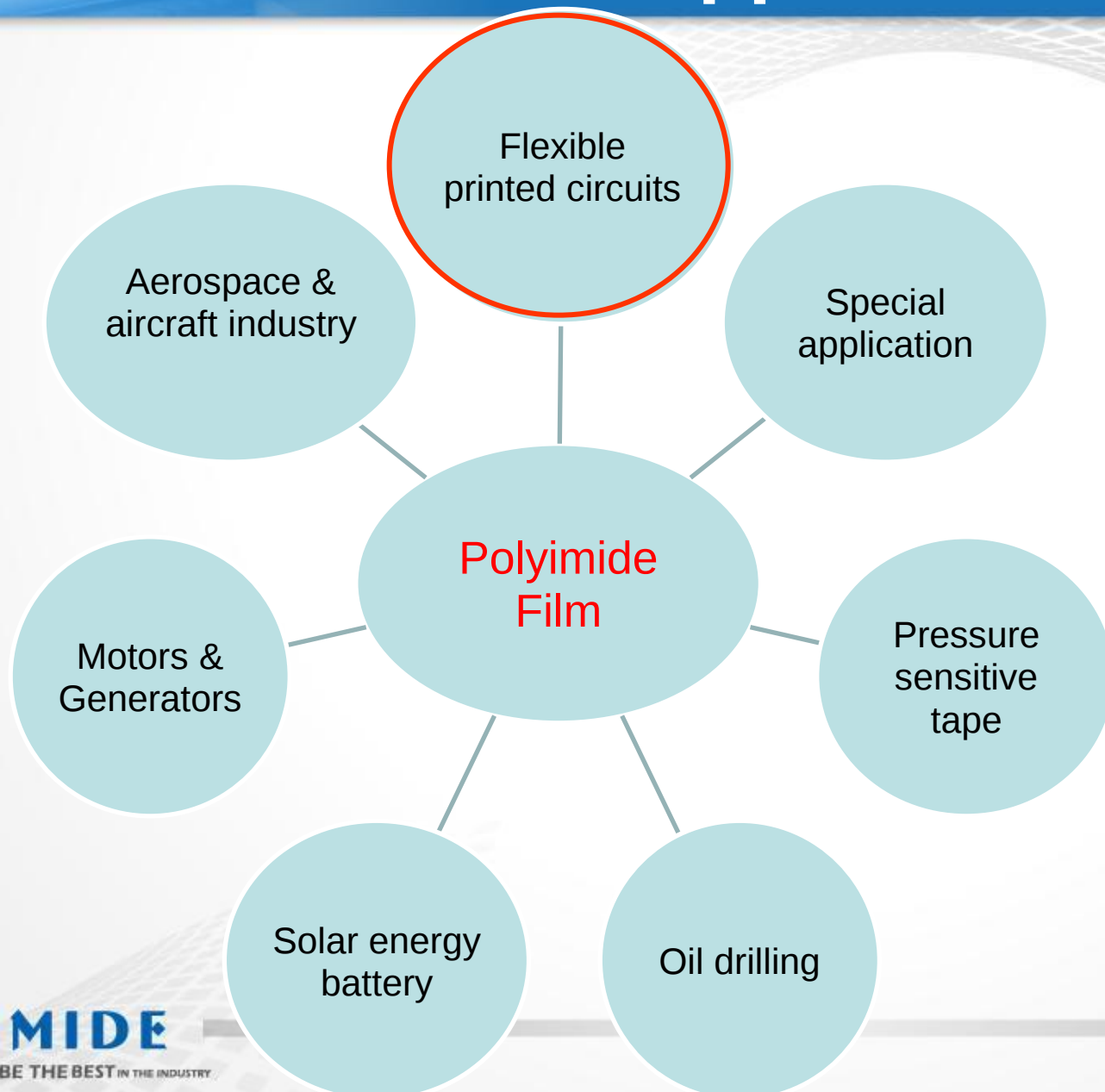
- 2000.06 Taimide Technology Incorp. Establishment.
- 2001.12 T1 Mass production line Installation.
- 2004.08 ISO9001 certification.
- 2004.12 Planning and designing of second plant.
- 2005.10 Co-developing Si-H PI film for Semi-Additive Process with Arakawa Chemical Industries,LTD.
- 2006.09 Start Running T3 Mass production line.
- 2007.05 Start running T2 Pilot line.
- 2007.12 Co-developing new generation PI film for IC package substrate with JFEC Corporation.
- 2010.07 Approved to be a tenant at Hsinchu Science Park for the new expansion place.
- 2010.12 ISO14001 & OHSAS18001 Certification.
- 2011.10 IPO in Taiwan Stock Exchange Market.
- 2012.Q2 T4 Mass production line planned to start running.



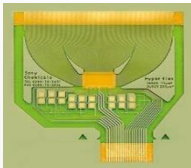
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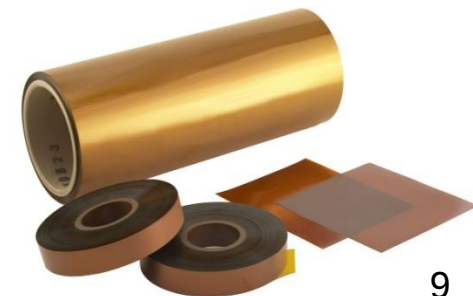
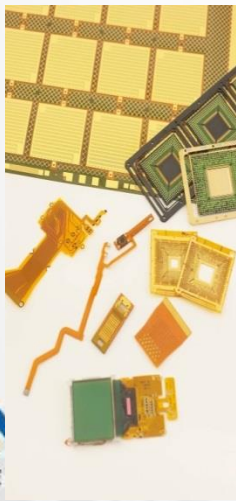
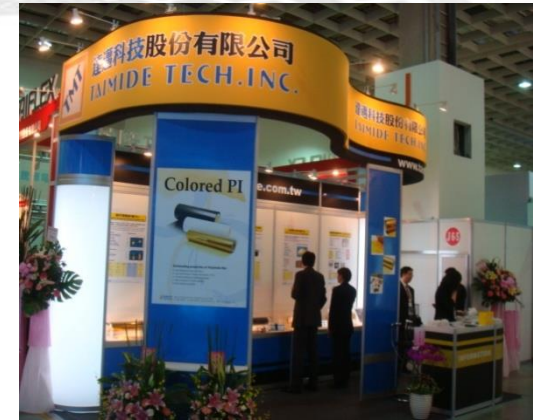
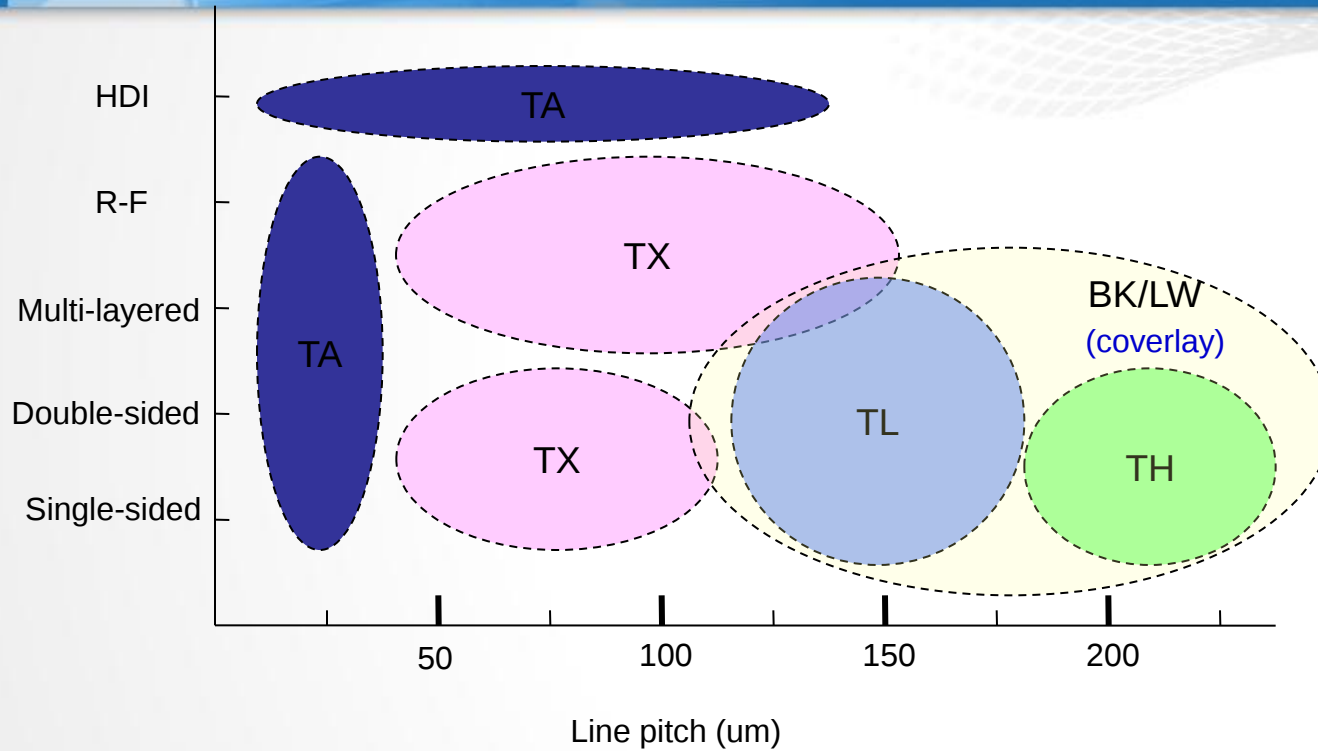
Applications



Applications

Application	TH	TL	TX	TA**	BK	LW
LED Light Bar 	Small size	Medium size	Large size		⊙	⊙
Display (LCM) 	Small size	Medium size	Large size		○	○
Notebook 	⊙	⊙				
Mobile Phone 	⊙	⊙			⊙	⊙
Package & Semi-additive 			⊙	⊙		
Photovoltaic Module 			⊙	⊙		

Application on PCBs



Product Lineup

Model	Thickness (mil)	Application
TH	H, 1, 2, 3	Normal FPCB / Stiffener
TL	H, 1	Fine pattern & large size FPCB (LCM module, Multi-layered...)
TX	0.3, H, 1, 1.5, 2	IC package substrate (Driver IC, R-F PCB.....)
BK	H, 1	Coverlay of FPCB (Smart phone, optical element, LED light bar...)
LW	1	Coverlay of FPCB (LED back light module)
TA	H, 1, 1.5	Semi-additive PCB & FPCB (HDI, IC substrate, COF, PV.....)



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軟板供應鏈

FPCB Supply Chain

Base Material

Polyimide

Copper foil

DuPont; Kaneka; **Taimide**
SKC

Nippon Mining; Olin
Furukawa; Taiwan Copper Foil

FCCL

CCL

Cover layer

RCCT Technology; Arisawa; ShinEtsu; Toray ; Taiflex ; AEM

FPC

Single-sided board

Double-sided board

Multi-layered board

Career; Foxconn Advanced Tech; Mektec; Flexium Interconnect; Advanced Flexible Circuits; Neoflex

Sunflex; Mutual-Tek; Complex Micro Interconnection; Uniflex; ICHIA



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未來產品研究發展方向及產業前景

Product Research and Industrial Prospect

FPC

- Black PI : Smart Phone Related
- White PI : LED Light Bar Related
- Ultra-thin PI: Smart Phone & Wearable...
- Platable PI: Green FPC, Semi-Additive
- Low DkDf PI: High Speed & Frequency..

Flexible DISPLAY

- OLED
- Touch Panel

Flexible PV

- Heat Resistance PI



2014年3Q營運績效



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Y14Q3營運績效

單位：新台幣百萬元

	Y14Q3	Y13Q3	QoQ(%)
營業收入	411	284	45%
營業毛利	139	90	55%
營業費用	44	34	31%
營業淨利	95	56	70%
其他收入/費用	15	(3)	-536%
稅前淨利	109	52	109%
稅後淨利	89	42	112%
每股盈餘(元)	0.79	0.38	108%
營業毛利率%	34%	32%	
營業費用率%	11%	12%	
營業淨利率%	23%	20%	
其他收入/費用率%	4%	-1%	
稅前淨利率%	27%	18%	
稅後淨利率%	22%	15%	



Y14Q1-Q3營運績效

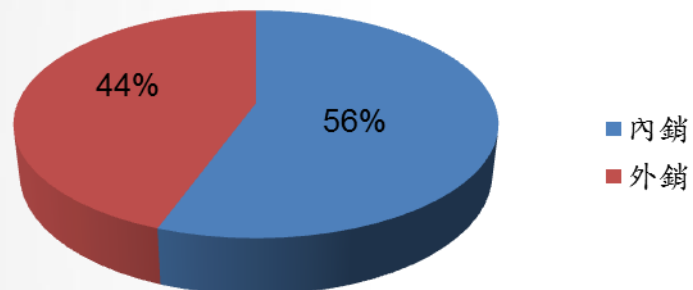
單位：新台幣百萬元

	Y14Q1-Q3	Y13Q1-Q3	YoY(%)
營業收入	1,050	698	51%
營業毛利	281	183	53%
營業費用	122	94	30%
營業淨利	159	90	77%
其他收入/費用	7	3	178%
稅前淨利	166	92	80%
稅後淨利	134	74	80%
每股盈餘(元)	1.21	0.66	83%
營業毛利率%	27%	26%	
營業費用率%	12%	13%	
營業淨利率%	15%	13%	
其他收入/費用率%	1%	0%	
稅前淨利率%	16%	13%	
稅後淨利率%	13%	11%	

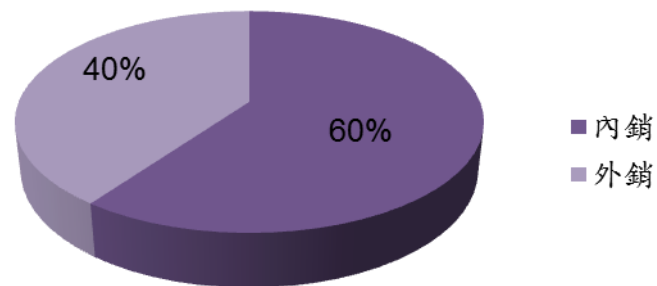


銷售市場

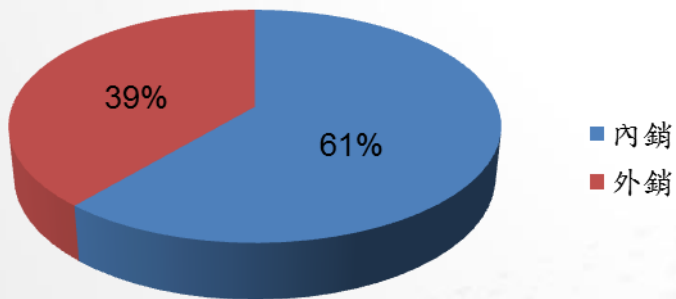
103年Q1-Q3



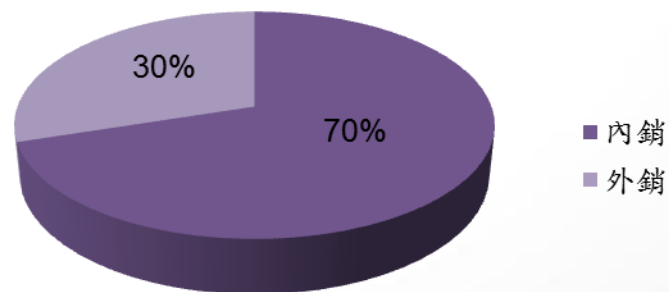
103年Q3



102年Q1-Q3

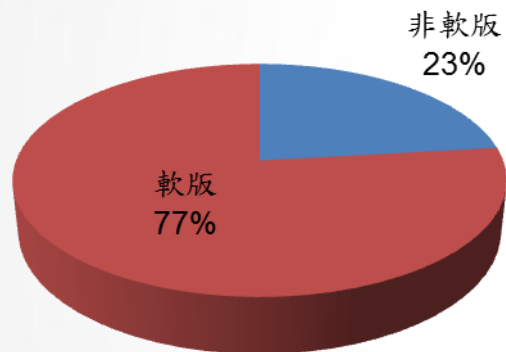


102年Q3

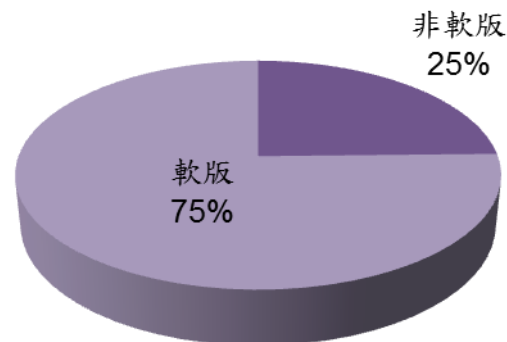


應用市場

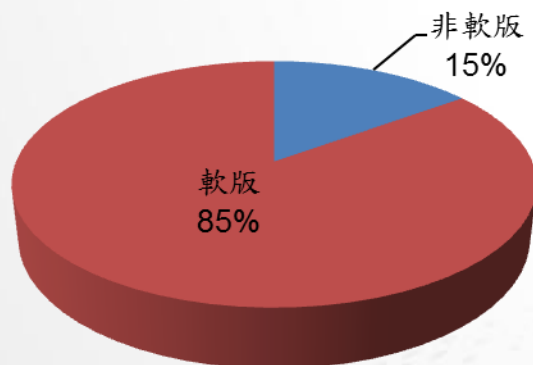
103年Q1-Q3



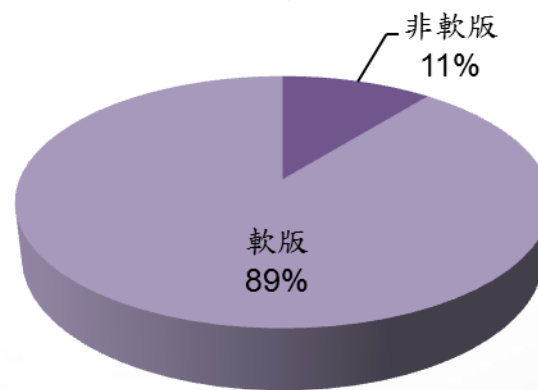
103年Q3



102年Q1-Q3



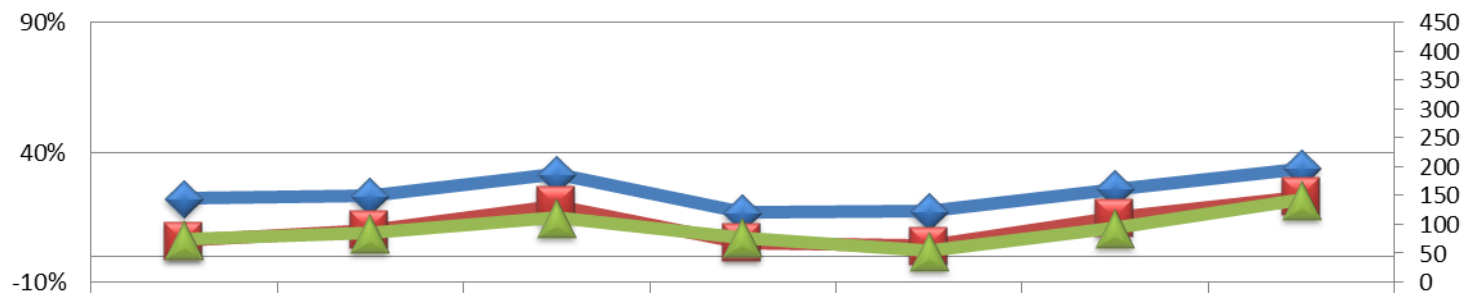
102年Q3



季度獲利趨勢

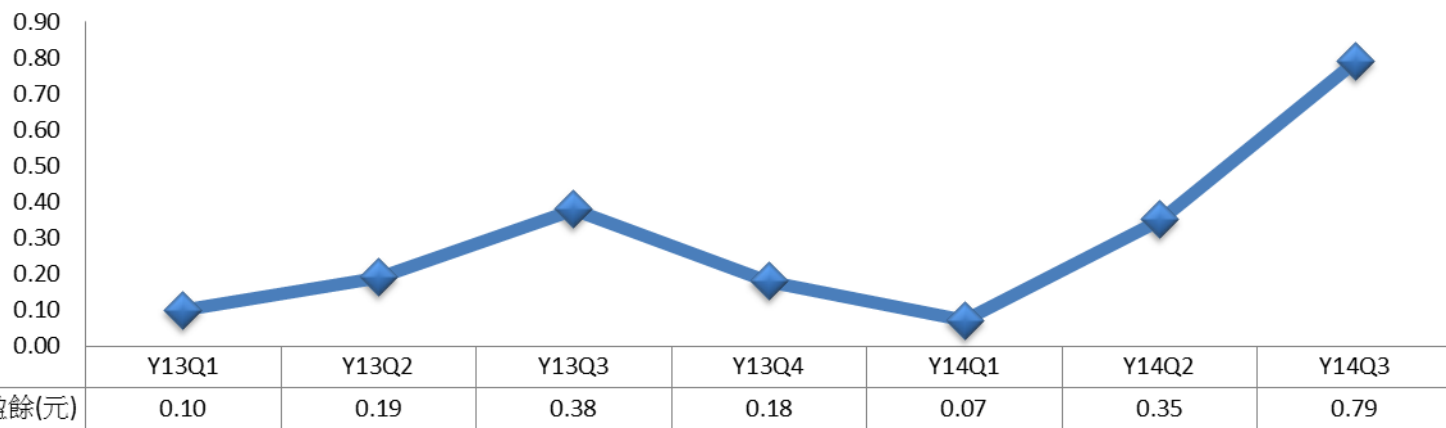
季度獲利趨勢

單位：新台幣百萬元



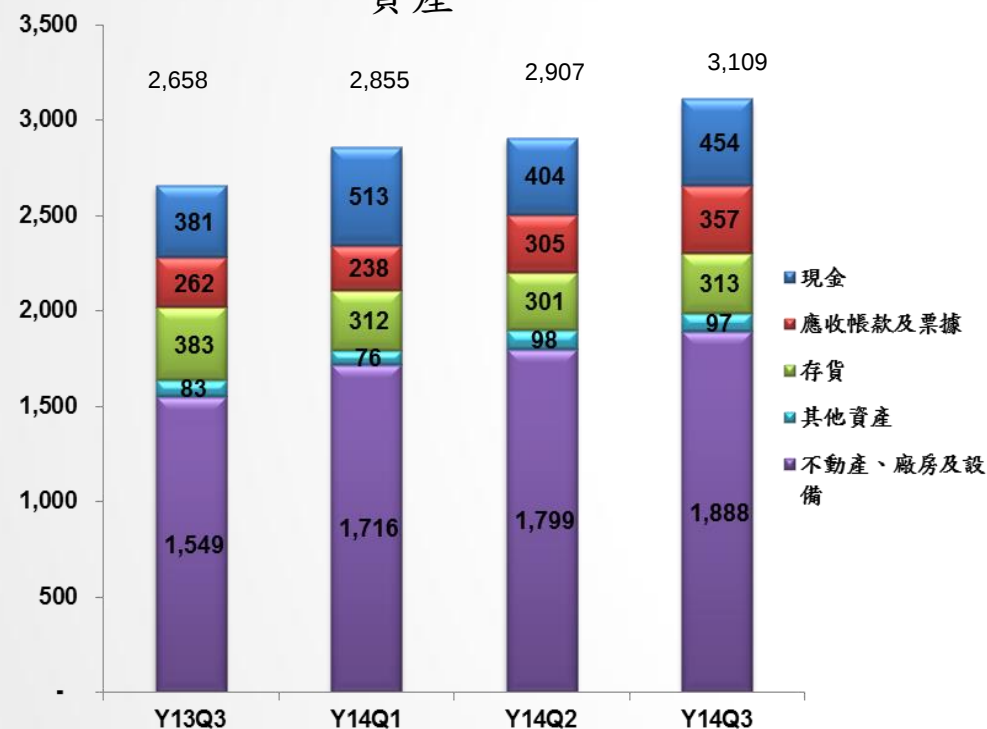
	Y13Q1	Y13Q2	Y13Q3	Y13Q4	Y14Q1	Y14Q2	Y14Q3
營業收入	177	238	284	269	281	358	411
營業毛利率%	22%	23%	32%	17%	17%	26%	34%
營業淨利率%	6%	10%	20%	5%	4%	15%	23%
稅後淨利率%	6%	9%	15%	7%	2%	11%	22%

每股盈餘(元)

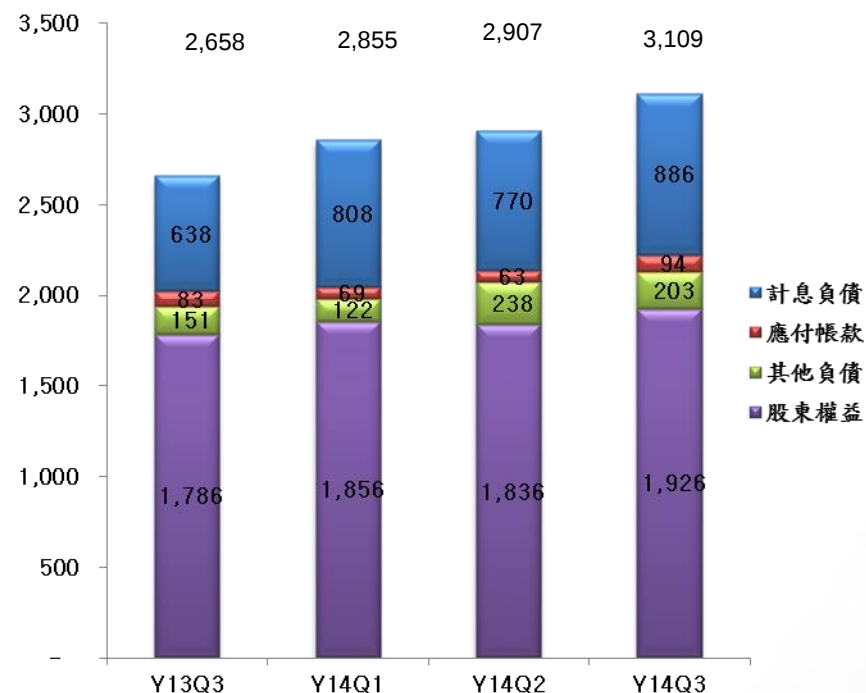


財務結構

資產



負債及股東權益



	Y13Q3	Y14Q1	Y14Q2	Y14Q3
負債比率	33%	35%	37%	38%
每股淨值	14.98	15.23	15.09	15.88

Q&A



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Thank you

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